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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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10/775,935

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EXAMINER

VAN, LUAN V

ART UNIT

PAPER NUMBER

1753

SHORTENED STATUTORY PERIOD OF RESPONSE	MAIL DATE	DELIVERY MODE
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3 MONTHS

12/20/2006

PAPER

**Please find below and/or attached an Office communication concerning this application or proceeding.**

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

**Office Action Summary**

Application No.

10/775,935

Applicant(s)

NOGAMI ET AL.

Examiner

Luan V. Van

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

**Period for Reply**

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

**Status**

- 1) ☒ Responsive to communication(s) filed on 09 November 2006.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

**Disposition of Claims**

- 4) ☒ Claim(s) 2-7 and 9-13 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 2-7 and 9-13 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

**Application Papers**

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on \_\_\_\_\_ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.  
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

**Priority under 35 U.S.C. § 119**

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some \* c) ☐ None of:
- ☐ Certified copies of the priority documents have been received.
  - ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
  - ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

**Attachment(s)**

- 1) ☐ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) ☐ Information Disclosure Statement(s) (PTO/SB/08)  
Paper No(s)/Mail Date \_\_\_\_\_.

- 4) ☐ Interview Summary (PTO-413)  
Paper No(s)/Mail Date. \_\_\_\_\_.
- 5) ☐ Notice of Informal Patent Application
- 6) ☐ Other: \_\_\_\_\_.

**DETAILED ACTION**

***Response to Amendment***

Applicant's amendment of November 9, 2006 does not render the application allowable.

***Status of Objections and Rejections***

The objection to the disclosure has been withdrawn in view of Applicant's amendment.

The rejection of claims 1 and 8 is obviated by Applicant's cancellation.

The rejection of claim 5 under 35 USC 102(e) is withdrawn in view of Applicant's amendment.

All other rejections from the previous office action are maintained.

***Claim Rejections - 35 USC § 102***

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

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Claims 2-4 are rejected under 35 U.S.C. 102(e) as being anticipated by Ting et al.

Regarding claims 2 and 4, Ting et al. teach a semiconductor manufacturing apparatus comprising: an electrolytic plating chamber 10 (Figs. 1-2) with which an electrolytic plating apparatus responsible for electrolytic plating of a substrate is constructed; an electrolytic polishing chamber 10 (the additional electrolytic plating chamber can be used as a polishing chamber, Figs. 1-2, column 4, lines 18-31) with which an electrolytic polishing apparatus responsible for electrolytic polishing of the substrate is constructed; and a conveying chamber 51 (Fig. 12) having installed therein a conveying instrument responsible for loading/unloading (column 17, lines 9-13) of the substrate to or from said electrolytic plating chamber and to or from said electrolytic polishing chamber, and being connected respectively to said electrolytic plating chamber and said electrolytic polishing chamber, wherein the electrolytic plating and/or polishing chamber with which the electrolytic plating and/or polishing apparatus is constructed comprises: a holder 13 (Figs. 2-3) for holding the substrate; a cup 12 (Figs. 2, 4-9) provided so as to oppose to said holder and is capable of forming a closed space, into which an electrolytic plating solution can be filled, together with the substrate held by said holder; and a nozzle 36 (Figs. 5-6) for supplying a process liquid onto a surface of the substrate held by said holder.

Shaft 16 and channel 36 in Fig. 5 of Ting et al. constitute a nozzle. A nozzle, according to Webster's dictionary, is defined as a projecting event of something, or a

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projecting part with an opening. Thus, Shaft 16 and channel 36 in Fig. 5 of Ting et al. broadly reads on the nozzle of the instant claim.

Regarding claim 3, the apparatus of Ting et al. is structurally capable of supplying a cleaning liquid.

### ***Claim Rejections - 35 USC § 103***

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

The factual inquiries set forth in *Graham v. John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:

1. Determining the scope and contents of the prior art.
2. Ascertaining the differences between the prior art and the claims at issue.
3. Resolving the level of ordinary skill in the pertinent art.
4. Considering objective evidence present in the application indicating obviousness or nonobviousness.

Claim 5 is rejected under 35 U.S.C. 103(a) as being unpatentable over Ting et al.

Ting et al. teach the apparatus as described above. Shaft 16 and channel 36 in Fig. 5 of Ting et al. constitute a nozzle, which is capable of supplying a cleaning liquid and an etching solution. Ting et al. differ from the instant claims in that the reference does not explicitly teach two nozzles.

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It would have been obvious to one having ordinary skill in the art at the time the invention was made to have modified the apparatus of Ting et al. by having an additional nozzle for different liquid, because it would prevent contamination between the cleaning liquid and the etching solution. Furthermore, adding additional nozzles would have been an obvious duplication of essential subject matter to one having ordinary skill in the art.

Claims 6, 7 and 9-13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ting et al. in view of Maydan et al.

Regarding claim 6, Ting et al. teach a semiconductor manufacturing apparatus comprising: an electrolytic plating chamber 49 (Fig. 12) with which an electrolytic plating apparatus responsible for electrolytic plating of a substrate is constructed; an electrolytic polishing chamber 49 with which an electrolytic polishing apparatus responsible for electrolytic polishing of the substrate is constructed; an electroless plating chamber 49 (the plating chamber of Ting et al. is structurally capable of being used as an electroless plating chamber in the absence of an applied current) with which an electroless plating apparatus responsible for electroless plating of the substrate is constructed; and a conveying chamber 51 having installed therein a conveying instrument responsible for loading/unloading of the substrate to or from said electrolytic plating chamber, to or from said electrolytic polishing chamber, to or from said electroless plating chamber, and being connected respectively to said electrolytic plating chamber, said electrolytic polishing chamber, and said electroless plating chamber, and said conveying chamber

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being connected with a liquid treatment chamber for supplying a process liquid, wherein said liquid treatment chamber comprises a holder for holding the substrate, and a nozzle for supplying the process liquid onto a surface of the substrate held by said holder. The additional plating chamber would read on the liquid treatment chamber of the instant claim.

Ting et al. differ from the instant claims in that the reference does not explicitly teach an annealing chamber.

Maydan et al. teach an apparatus comprising an annealing chamber 211 (Fig. 1).

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have modified the apparatus of Ting et al. by using the annealing chamber of Maydan et al., because an annealing chamber is typically utilized in substrate processing systems to enhance the properties of the deposited materials by recrystallization of the deposited films, such as copper films, which can cause the flow of the deposited material to fill voids formed in features, purify layers of contaminants, such as oxygen, encourage diffusion of dopants, such as phosphorus, in the deposited materials, and manage crystal growth and orientation to control film properties (column 7, lines 49-61 of Maydan et al.)

Regarding claim 7, Ting et al. teach said conveying instrument is responsible for loading/unloading of the substrate to or from said electrolytic plating chamber, to or from said electrolytic polishing chamber, to or from said electroless plating chamber, and is also responsible for loading/unloading of the substrate to or from said liquid treatment chamber (column 17, lines 3-34).

Regarding claims 9 and 13, Shaft 16 and channel 36 in Fig. 5 of Ting et al. constitute a nozzle, which is capable of supplying a cleaning liquid and an etching solution. Ting et al. differ from the instant claims in that the reference does not explicitly teach two nozzles. It would have been obvious to one having ordinary skill in the art at the time the invention was made to have modified the apparatus of Ting et al. by having an additional nozzle for different liquid, because it would prevent contamination between the cleaning liquid and the etching solution. Furthermore, adding additional nozzles would have been an obvious duplication of essential subject matter to one having ordinary skill in the art.

Regarding claims 10 and 12, Ting et al. teach the electrolytic plating or polishing chamber with which the electrolytic plating or polishing apparatus is constructed comprises: a holder 13 (Figs. 2-3) for holding the substrate; a cup 12 (Figs. 2, 4-9) provided so as to oppose to said holder and is capable of forming a closed space, into which an electrolytic plating solution can be filled, together with the substrate held by said holder; and a nozzle 18 (Figs. 5-6) for supplying a process liquid onto a surface of the substrate held by said holder.

Regarding claim 11, the apparatus of Ting et al. is structurally capable of operating with a cleaning liquid.

### ***Response to Arguments***

In the arguments presented on page 2 of the amendment, the applicant argues that the nozzle 18 of Ting et al. is not used for supplying a process liquid onto a surface



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of the substrate held by the holder. The examiner acknowledges that the statement is correct. However, as stated in the office action above, Shaft 16 and channel 36 in Fig. 5 of Ting et al. constitute a nozzle. A nozzle, according to Webster's dictionary, is defined as a projecting event of something, or a projecting part with an opening. Thus, Shaft 16 and channel 36 in Fig. 5 of Ting et al. broadly reads on the nozzle of the instant claim. Therefore, Ting et al. anticipate independent claims 2 and 4.

### ***Conclusion***

**THIS ACTION IS MADE FINAL.** See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a). A shortened statutory period for reply to this final action is set to expire **THREE MONTHS** from the mailing date of this action. In the event a first reply is filed within **TWO MONTHS** of the mailing date of this final action and the advisory action is not mailed until after the end of the **THREE-MONTH** shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than **SIX MONTHS** from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Luan V. Van whose telephone number is 571-272-8521. The examiner can normally be reached on M-F 9:30-6:00.


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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nam Nguyen can be reached on 571-272-1342. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

LVV

December 14, 2006



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